

MAX710/MAX711 **3.3V/5V or Adjustable,** **Step-Up/Down DC-DC Converters**

General Description

The MAX710/MAX711 integrate a step-up DC-DC converter with a linear regulator to provide step-up/down voltage conversion. They are optimized for battery applications where the input varies above and below the regulated output voltage. They have an input range from +1.8V to +11V. Typical efficiency when boosting battery inputs is 85%.

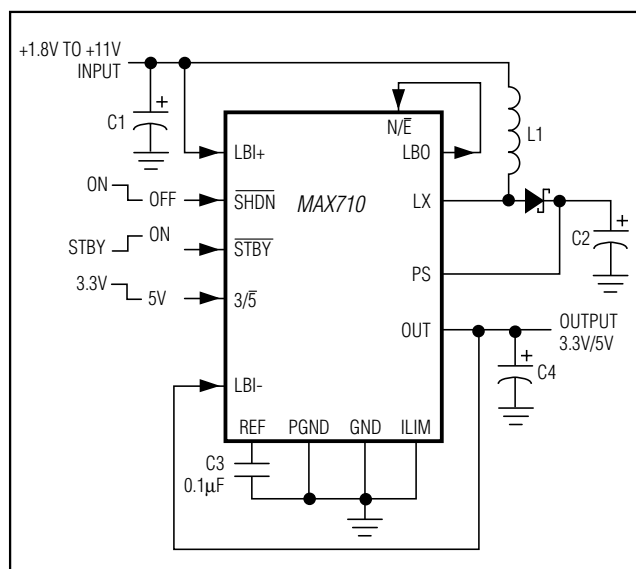
The MAX710/MAX711 can be configured for minimum noise or optimum efficiency. Shutdown control turns off the part completely, disconnecting the input from the output ($I_{SHDN} = 0.2\mu A$). Standby control turns off only the step-up converter and leaves the low-power linear regulator active ($I_Q = 7\mu A$).

The MAX710 has a preset 3.3V or 5V output voltage. The MAX711 has an adjustable output that can be set from +2.7V to +5.5V with two resistors. Both devices come in 16-pin narrow SO packages.

Applications

Single-Cell, Lithium-Powered Portable Devices
 Digital Cameras
 2- to 4-Cell AA Alkaline Hand-Held Equipment
 3.3V and Other Low-Voltage Systems
 2-, 3-, and 4-Cell Battery-Powered Equipment
 Battery-Powered Devices with AC Input Adapters

Typical Operating Circuit



Features

Step-Up/Down Voltage Conversion

+1.8V to +11V Input Range

Output:

5V/250mA at $V_{IN} = 1.8V$

5V/500mA at $V_{IN} = 3.6V$

No External FETs Required

Load Disconnected from Input in Shutdown

Battery Drain:

200 μA No-Load ($V_{IN} = 4V$)

7 μA in Standby

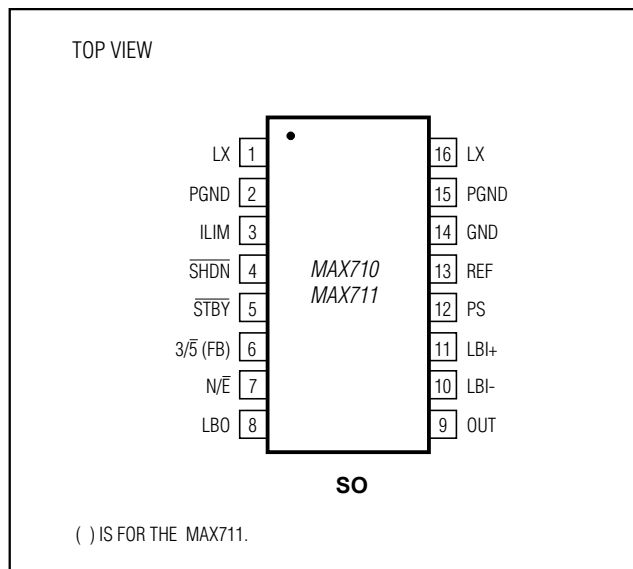
0.2 μA when Off

Low-Noise and High-Efficiency Modes

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX710C/D	0°C to +70°C	Dice
MAX710ESE	-40°C to +85°C	16 Narrow SO
MAX711C/D	0°C to +70°C	Dice
MAX711ESE	-40°C to +85°C	16 Narrow SO

Pin Configuration



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ABSOLUTE MAXIMUM RATINGS

PS, LX, OUT to GND.....-0.3V to +11.5V
 ILIM, SHDN, STBY, FB, 3/5, N/E, LBO,
 LBI-, LBI+, REF to GND-0.3V to (VPS + 0.3V)
 PGND to GND-0.3V to +0.3V
 REF Short Circuit to GNDContinuous
 IOUT.....700mA

Continuous Power Dissipation (TA = +70°C)
 SO (derate 8.70mW/°C above +70°C).....696mW
 Operating Temperature Range-40°C to +85°C
 Storage Temperature Range-65°C to +160°C
 Junction Temperature+150°C
 Lead Temperature (soldering, 10sec)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(VPS = 5.6V, STBY = PS, CREF = 0.1μF, COUT = 4.7μF, TA = -40°C to +85°C, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Input Voltage	N/E = PS		1.8		11.0	V
	N/E = GND (Note 2)		1.8		7.0	
Full Load Start-Up Voltage				0.9		V
Output Voltage (MAX710)	3/5 = low, IOUT = 0 to 250mA	TA = 0°C to +85°C	4.8	5.0	5.2	V
		TA = -40°C to +85°C	4.6	5.0	5.3	
	3/5 = high, IOUT = 0 to 250mA, VPS = 4.7V	TA = 0°C to +85°C	3.17	3.3	3.43	
		TA = -40°C to +85°C	3.05	3.3	3.55	
Output Voltage-Adjustment Range	MAX711		FB		5.5	V
Output Voltage Load Regulation	0 < IOUT < 250mA, STBY = PS			0.5		%
Output Voltage Line Regulation	STBY = PS, 1.8V to 5V			0.3		%/V
Quiescent Current	VSTBY = VSHDN = logic high, current measured into PS pin; ILOAD = 0			100	140	μA
Standby Quiescent Current	VSTBY = 0V			7	16	μA
Shutdown Quiescent Current	VSHDN = 0V			0.1	5	μA
Reference Voltage	TA = 0°C to +85°C, IREF = 0		1.24	1.28	1.31	V
	TA = -40°C to +85°C, IREF = 0		1.23	1.28	1.32	
Standby Output Current	VSTBY = 0V, linear regulator				10	mA
FB Voltage	MAX711, OUT = FB	TA = 0°C to +85°C	1.20	1.25	1.29	mV
		TA = -40°C to +85°C	1.18	1.25	1.31	
Load Regulation	MAX711, OUT = FB	0mA ≤ ILOAD ≤ 250mA		0.1	1	%
FB Input Current	FB = 1.25V			1	50	nA
LX On-Resistance	VPS = 5.6V			0.2	0.6	Ω
	MAX710, VPS = 3.7V			0.3	0.9	
	MAX711, VPS = 2.7V			0.6	1.2	
LX Leakage Current	VLX = 5.6V			0.1	1	μA
LX Current Limit	ILIM = PS		0.5	0.8	1.3	A
	ILIM = GND		1.1	1.5	1.95	

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ELECTRICAL CHARACTERISTICS (continued)

(V_{PS} = 5.6V, $\overline{\text{STBY}}$ = PS, C_{REF} = 0.1μF, C_{OUT} = 4.7μF, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Output PFET Resistance	V _{OUT} = 5.0V		0.7	1.3	Ω
	MAX710, V _{OUT} = 3.0V		1.3	2.4	
	MAX711, V _{OUT} = 2.7V		1.6	3.0	
Output PFET Leakage	V _{PS} = 3V, V _{OUT} = 0V		0.4	3	μA
Thermal Shutdown	$\overline{\text{STBY}}$ = PS		150		°C
Thermal Shutdown Hysteresis	$\overline{\text{STBY}}$ = PS		20		°C
LOGIC					
Input Low Voltage	$\overline{\text{STBY}}$, $\overline{\text{SHDN}}$, N/ $\overline{\text{E}}$, 3/ $\overline{\text{5}}$, ILIM			0.4	V
Input High Voltage	$\overline{\text{STBY}}$, $\overline{\text{SHDN}}$, N/ $\overline{\text{E}}$, 3/ $\overline{\text{5}}$, ILIM	1.6			V
Input Bias Current	$\overline{\text{STBY}}$, $\overline{\text{SHDN}}$, N/ $\overline{\text{E}}$, 3/ $\overline{\text{5}}$, ILIM		1	50	nA
LBI/LBO COMPARATOR					
Input Range LBI-, LBI+	(Note 3)	1.2		10	V
Input Bias Current LBI-, LBI+	V _{LBI-} , V _{LBI+} = 1.25V		1	50	nA
Hysteresis		6	40	100	mV
LBI/LBO Offset Voltage	V _{LBI-} = 1.25V	-25		+25	mV
LBO Output Voltage	I _{LBO} = 2mA, V _{LBI-} = 1.25V, V _{LBI+} = 1V			0.4	V
	I _{LBO} = -300μA, V _{LBI-} = 1.25V, V _{LBI+} = 2V	V _{PS} - 0.2V			

Note 1: Specifications at -40°C are guaranteed by design, not production tested.

Note 2: Guaranteed by design (see Table 1).

Note 3: The LBO comparator provides the correct result as long as one input is within the specified input range.

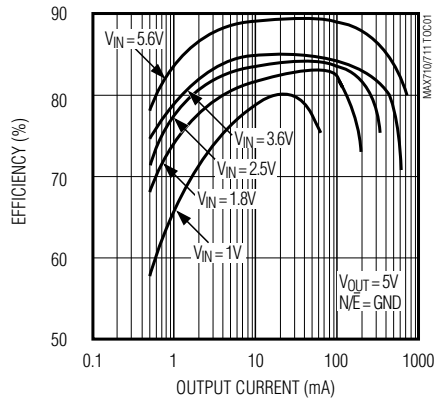
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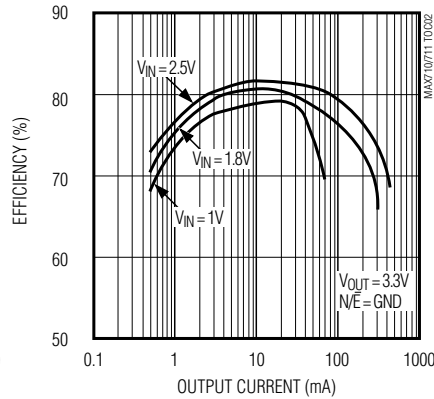
Typical Operating Characteristics

($T_A = +25^\circ\text{C}$, unless otherwise noted.)

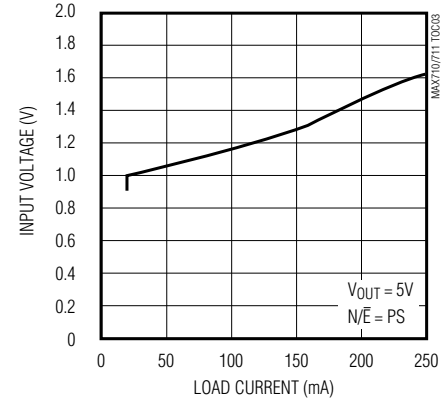
**EFFICIENCY vs. OUTPUT CURRENT—
HIGH-EFFICIENCY MODE
($V_{OUT} = 5V$)**



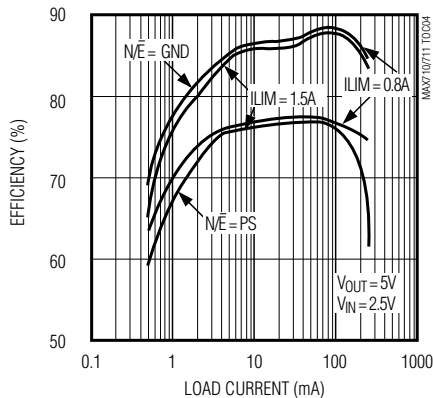
**EFFICIENCY vs. OUTPUT CURRENT—
HIGH-EFFICIENCY MODE
($V_{OUT} = 3.3V$)**



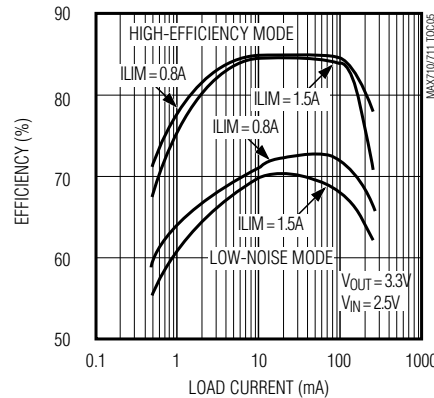
**MINIMUM START-UP INPUT VOLTAGE
vs. LOAD CURRENT**



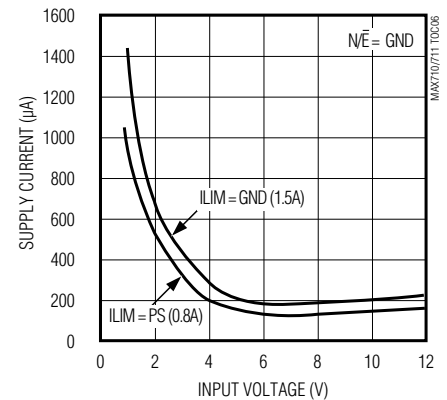
**EFFICIENCY vs. LOAD CURRENT—
HIGH-EFFICIENCY AND LOW-NOISE MODES
($V_{OUT} = 5V$)**



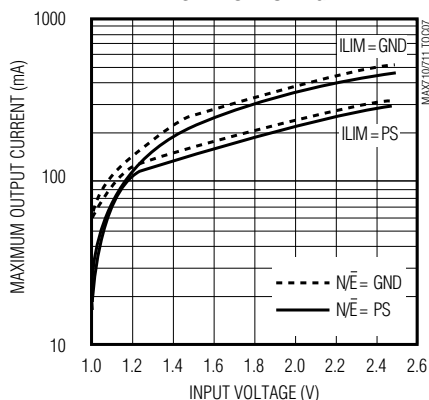
**EFFICIENCY vs. LOAD CURRENT—
HIGH-EFFICIENCY AND LOW-NOISE MODES
($V_{OUT} = 3.3V$)**



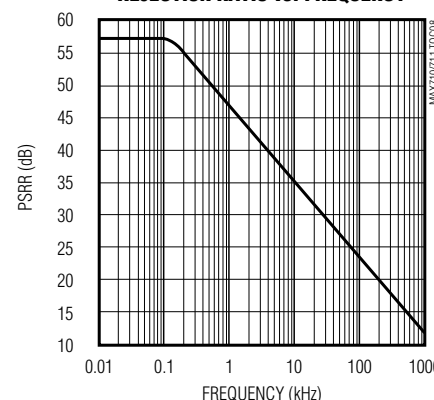
**NO-LOAD BATTERY CURRENT
vs. INPUT VOLTAGE**



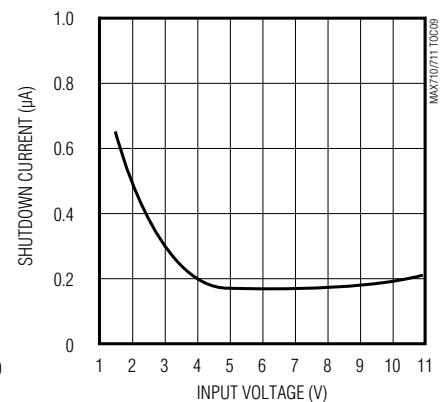
**MAXIMUM OUTPUT CURRENT
vs. INPUT VOLTAGE**



**LINEAR-REGULATOR POWER-SUPPLY
REJECTION RATIO vs. FREQUENCY**



**SHUTDOWN CURRENT
vs. INPUT VOLTAGE**



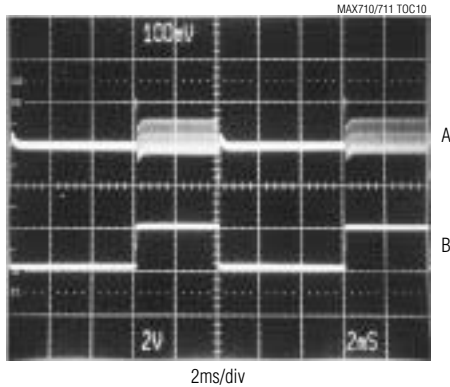
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Typical Operating Characteristics (continued)

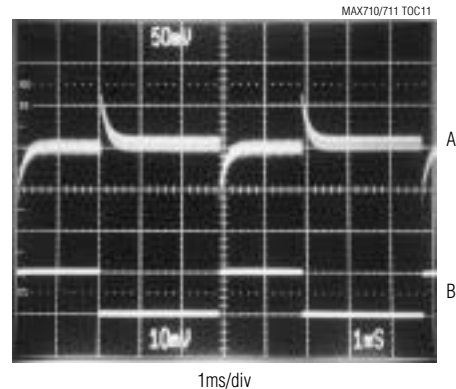
($T_A = +25^\circ\text{C}$, unless otherwise noted.)

LINE-TRANSIENT RESPONSE



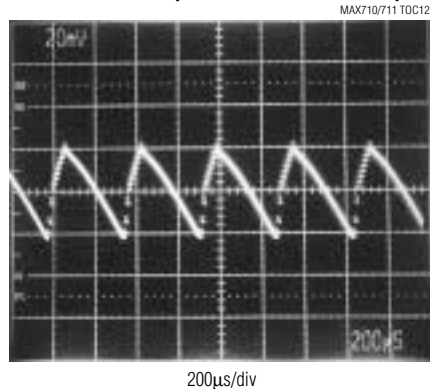
A: $V_{OUT} = 3.3\text{V}$ (100mV/div, AC COUPLED), $N/\bar{E} = \text{GND}$
 B: $V_{IN} = 2\text{V TO } 4\text{V}$, $I_{OUT} = 100\text{mA}$

LOAD-TRANSIENT RESPONSE



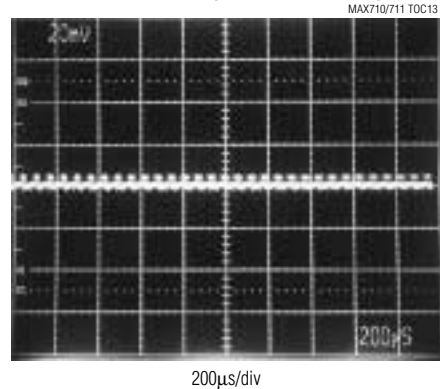
A: $V_{OUT} = 3.3\text{V}$ (50mV/div, AC COUPLED), $N/\bar{E} = \text{PS}$
 B: $I_{OUT} = 10\text{mA TO } 100\text{mA}$

OUTPUT RIPPLE (HIGH-EFFICIENCY MODE)



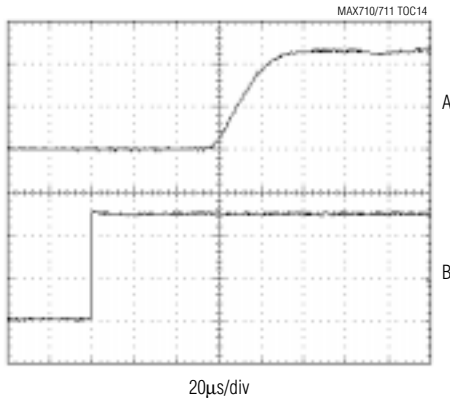
$V_{IN} = 2.5\text{V}$, $I_{OUT} = 20\text{mA}$, $N/\bar{E} = \text{GND}$
 $V_{OUT} = 5\text{V}$ (20mV/div, AC COUPLED), $I_{OUT} = 20\text{mA}$

OUTPUT RIPPLE (LOW-NOISE MODE)



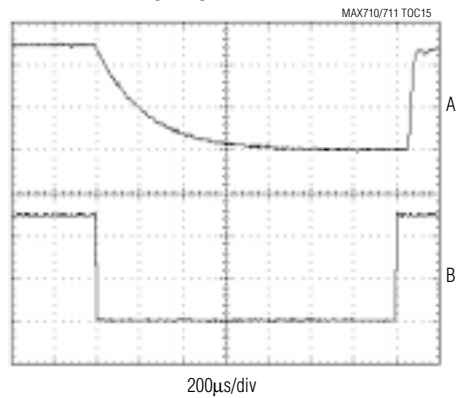
$V_{IN} = 2.5\text{V}$, $I_{OUT} = 20\text{mA}$, $N/\bar{E} = \text{PS}$
 $V_{OUT} = 5\text{V}$ (20mV/div, AC COUPLED), $I_{OUT} = 20\text{mA}$

START-UP DELAY



A: V_{OUT} (2V/div), $I_{OUT} = 100\text{mA}$
 B: V_{SHDN} (2V/div)

TURN-OFF DELAY



A: V_{OUT} (2V/div), $I_{OUT} = 100\text{mA}$
 B: V_{SHDN} (2V/div)

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Pin Description

PIN		NAME	FUNCTION
MAX710	MAX711		
1	1	LX	Drain Connection for internal N-channel power MOSFET
2	2	PGND	Power Ground
3	3	ILIM	Inductor Current-Limit-Select Input. Connect to GND for 1.5A limit and to PS for 0.8A limit.
4	4	$\overline{\text{SHDN}}$	Shutdown Input. When low, the entire circuit is off and OUT is actively pulled to GND.
5	5	$\overline{\text{STBY}}$	Standby Input. Connect to GND to disable boost circuit. Connect to PS for normal operation.
6	—	$3/\overline{5}$	Selects the output voltage. Connect to GND for 5V output and to OUT for 3.3V output.
—	6	FB	Feedback Input
7	7	$\text{N}/\overline{\text{E}}$	Selects low-noise or high-efficiency mode. Connect to GND for high efficiency and to PS for lowest noise. See <i>Operating Configurations</i> section.
8	8	LBO	Low-Battery Comparator Output
9	9	OUT	Linear-Regulator Output. Bypass with a 4.7 μF capacitor to GND.
10	10	LBI-	Negative Input to Low-Battery Comparator
11	11	LBI+	Positive Input to Low-Battery Comparator
12	12	PS	Source of internal PFET regulator. The IC is powered from PS.
13	13	REF	1.28V Reference Voltage Output. Bypass with a 0.1 μF capacitor to GND.
14	14	GND	Analog Ground. Must be low impedance. Solder directly to ground plane.
15	15	PGND	Power Ground
16	16	LX	Drain Connection for internal N-channel power MOSFET

Detailed Description

The MAX710/MAX711 integrate a step-up DC-DC converter with a linear regulator to provide step-up/down voltage conversion. The step-up switch-mode regulator contains an N-channel power MOSFET switch. It also shares a precision voltage reference with a linear regulator that contains a P-channel MOSFET pass element (Figure 1).

Step-Up Operation

A pulse-frequency-modulation (PFM) control scheme with a constant 1 μs off-time and variable on-time controls the N-channel MOSFET switch. The N-channel switch turns off when the part reaches the peak current limit or the 4 μs maximum on-time. The ripple frequency is a function of load current and input voltage.

Step-Down Operation

The low-dropout linear regulator consists of a reference, an error amplifier, and a P-channel MOSFET. The reference is connected to the error amplifier's inverting

input. The error amplifier compares this reference with the selected feedback voltage and amplifies the difference. The difference is conditioned and applied to the P-channel pass transistor's gate.

Operating Configurations

The MAX710/MAX711 have several operating configurations to minimize noise and optimize efficiency for different input voltage ranges. These configurations are accomplished via the $\text{N}/\overline{\text{E}}$ input, which controls operation of the on-chip linear regulator.

With $\text{N}/\overline{\text{E}}$ low, the linear regulator behaves as a 0.7 Ω (at 5V output) PFET switch when the IC is boosting, and as a conventional linear regulator when $V_{\text{IN}} > V_{\text{OUT}}$. This provides optimum boost efficiency, but the PFET does little to reject boost-converter output ripple. With $\text{N}/\overline{\text{E}}$ high, boost ripple rejection is optimized by maintaining headroom (V_{FV} , typically 0.5V at 5V output) across the linear regulator. Boost mode efficiency is then about 10% lower than with $\text{N}/\overline{\text{E}}$ high.

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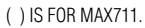


Figure 1. Functional Diagram

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In high-efficiency mode ($N/\bar{E} = \text{low}$), the maximum input voltage is limited to 7V. This voltage limitation is easily overcome, however, by configuring the LBO output to change modes based on input voltage, allowing an 11V maximum input with high-efficiency configurations. Four operating configurations are described in Table 1 and in the following subsections.

Table 1. Operating Configurations

NO.	DESCRIPTION	INPUT VOLTAGE	CONNECTIONS
1	High efficiency, 7V max V_{IN}	Up to 7V	$N/\bar{E} = \text{GND}$
2	High efficiency, $V_{BATT} < V_{OUT}$ (Figure 2a)	Up to 11V	LBO = $N/\bar{E}$ LBI- = V_{OUT} LBI+ = V_{IN}
3	High efficiency, 11V, $V_{BATT} < 6.5V$ (Figure 2b)	Up to 11V	LBO = $N/\bar{E}$ LBI- = REF LBI+ = R5, R6
4	Low noise	Up to 11V	$N/\bar{E} = \text{PS}$

Configuration 1: High Efficiency, 7V Max V_{IN}

With $N/\bar{E}$ connected to GND, when the IC boosts, the linear regulator operates only as a switch, with minimum forward drop, until $V_{IN} > V_{OUT}$ (where linear regulation begins). This configuration is limited to no more than 7V input, but provides best efficiency for battery-only operation or low-voltage AC adapter usage.

Configuration 2: High Efficiency, $V_{BATT} < V_{OUT}$

In this configuration, $N/\bar{E}$ is driven high by LBO when $V_{IN} > V_{OUT}$ (Figure 2a). When $V_{IN} < V_{OUT}$, the IC boosts, and the linear regulator operates as a switch, with minimum forward drop. When $V_{IN} > V_{OUT}$, the linear regulator operates with V_{FV} forward drop, while V_{PS} increases by V_{FV} so that OUT maintains regulation. V_{FV} is set inside the IC to approximately 0.5V (at 5V V_{OUT}). When V_{IN} is only slightly higher than V_{OUT} , conversion efficiency is poorer than in configuration 1, so configuration 2 is most suitable when the battery voltage is less than V_{OUT} , but the AC adapter output is greater than V_{OUT} .

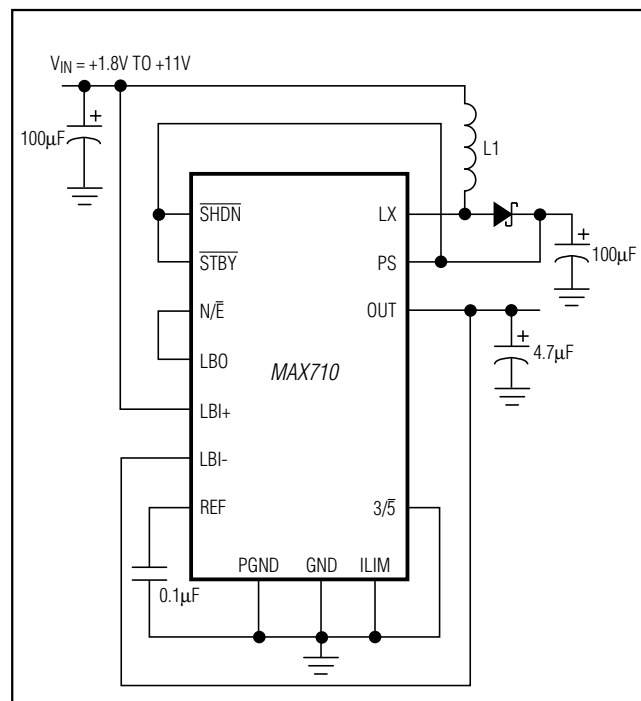


Figure 2a. High-Efficiency Operating Configuration for $V_{BATT} < V_{OUT}$

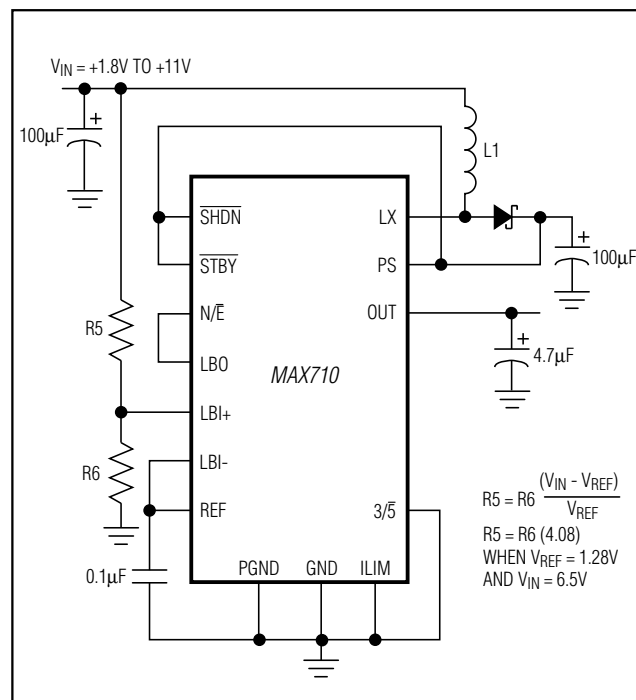


Figure 2b. High-Efficiency Operating Configuration for $V_{BATT} < 6.5V$

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Table 2. Component Selection

INDUCTORS (L1)	CAPACITORS	RECTIFIERS (D1)
Sumida CD75-220 (1.5A), CDRH-74-220 (1.23A), or CD54-220	100μF, 16V low-ESR tantalum capacitor AVX TPSE107M016R0100 or Sprague 593D107X0016E2W	Schottky diode Motorola MBRS130T3
Coilcraft DO33-08P-223	4.7μF, 16V tantalum capacitor Sprague 595D475X0016A2T	

where V_{LBT} is the desired threshold of the low-battery detector and V_{LBI} is the voltage applied to the inverting input of the low-battery comparator. Since LBI current is less than 50nA, R3 and R4 can be large (typically 100kΩ to 1MΩ), minimizing input supply loading. If the low-battery comparator is not used, connect LBI+ to PS and LBI- to REF, leaving LBO unconnected.

Inductor Selection

A 22μH inductor value performs well in most MAX710/MAX711 applications. The inductance value is not critical, however, since the MAX710/MAX711 work with inductors in the 18μH to 100μH range. Smaller inductance values typically offer a smaller size for a given series resistance, allowing the smallest overall circuit dimensions. Circuits using larger inductance values exhibit higher output current capability and larger physical dimensions for a given series resistance. The inductor's incremental saturation current rating should be greater than the peak switch-current limit, which is 1.5A for ILIM = GND and 0.8A for ILIM = PS. However, it is generally acceptable to bias most inductors into saturation by as much as 20%, although this slightly reduces efficiency. The inductor's DC resistance significantly affects efficiency. See Tables 2 and 3 for a list of suggested inductors and suppliers.

Capacitor Selection

A 100μF, 16V, 0.1Ω equivalent series resistance (ESR), surface-mount tantalum (SMT) output filter capacitor, C2, typically exhibits 50mV output ripple when stepping up from 2V to 5V at 100mA. Smaller capacitors (down to 10μF with higher ESRs) are acceptable for light loads or in applications that can tolerate higher output ripple. The ESR of both bypass and filter capacitors affects efficiency and output ripple. Output voltage ripple is the product of the peak inductor current and the output capacitor's ESR. Use low-ESR capacitors for best performance, or connect two or more filter capacitors in parallel. Low-ESR, SMT capacitors are currently available from Sprague (595D series) and AVX (TPS series). Sanyo OS-CON organic-semiconductor through-hole capacitors also exhibit very low ESR and are especially

useful for operation at cold temperatures. The output capacitor, C3, needs to be only 4.7μF to maintain linear regulator stability. See Tables 2 and 3 for a list of suggested capacitors and suppliers.

Rectifier Diode

For optimum performance, use a switching Schottky diode. Refer to Tables 2 and 3 for the suggested diode and supplier.

Applications Information

The MAX710/MAX711 high-frequency operation makes PC layout important for minimizing ground bounce and noise. Keep the IC's GND pin and the ground leads of C1 and C2 (Figure 1) less than 0.2in. (5mm) apart. Also keep all connections to the FB and LX pins as short as possible. To maximize output power and efficiency and minimize output ripple voltage, use a ground plane and solder the IC's GND pin directly to the ground plane.

Table 3. Component Suppliers

SUPPLIER	PHONE	FAX
AVX	(803) 946-0690	(803) 626-3123
Coilcraft	(847) 639-6400	(847) 639-1469
Motorola	(602) 303-5454	(602) 994-6430
Sanyo	(619) 661-6835	(619) 661-1055
Sprague	(603) 224-1961	(603) 224-1430
Sumida	(847) 956-0666	(847) 956-0702

Chip Information

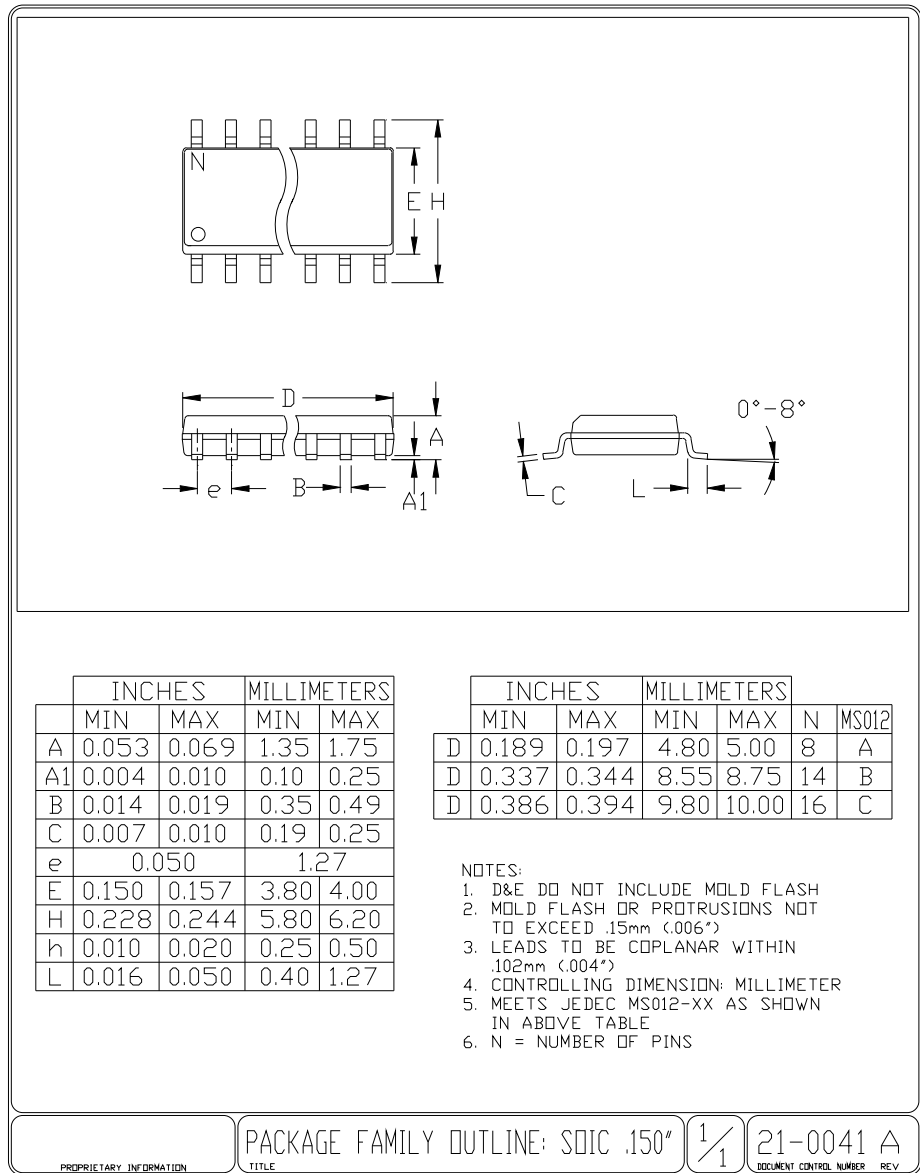
TRANSISTOR COUNT: 661

SUBSTRATE CONNECTED TO GND

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Package Information



MAX710/MAX711

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NOTES



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.